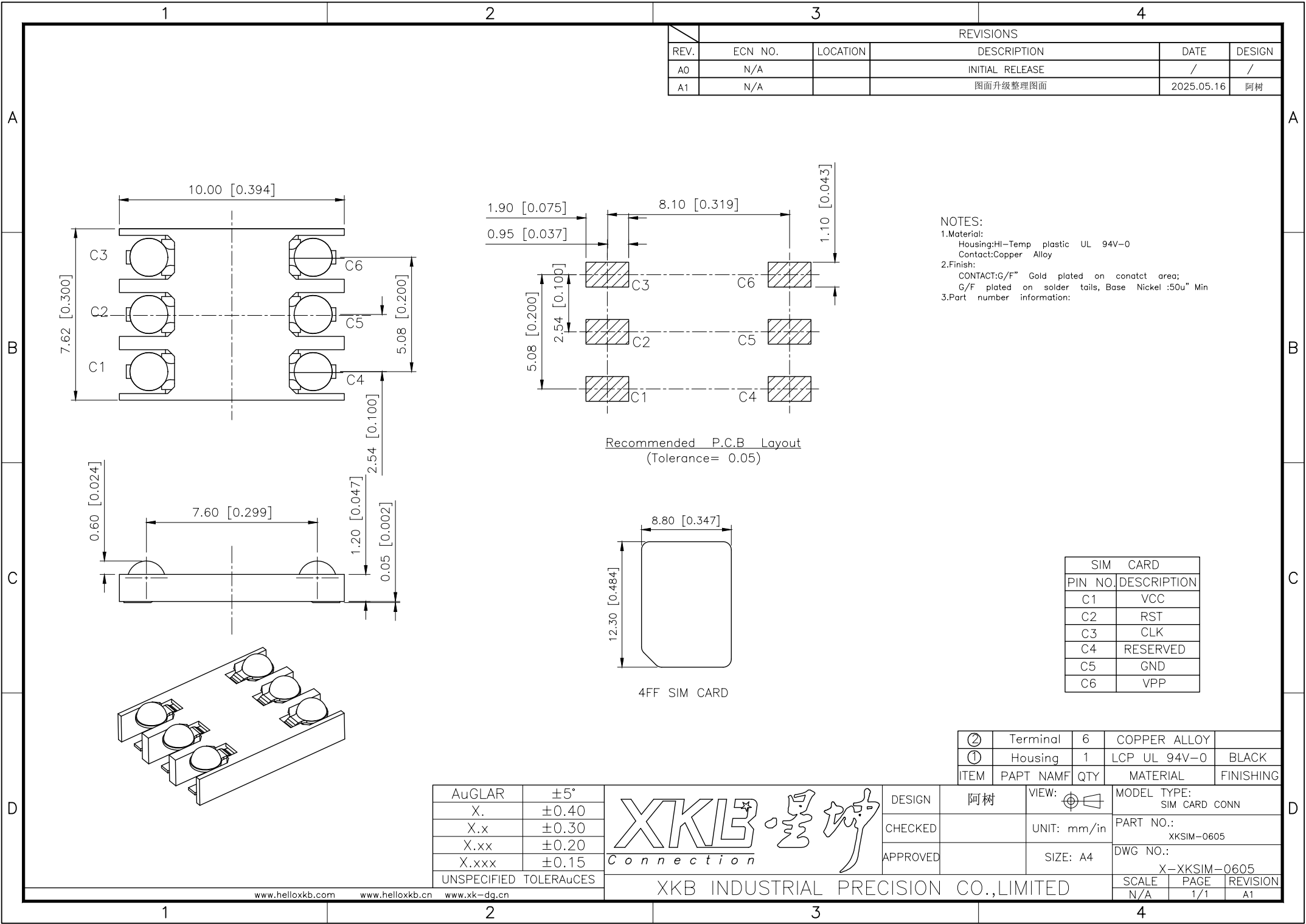




REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.05.16	阿树

NOTES:
1.Material:
Housing:HI-Temp plastic UL 94V-0
Contact:Copper Alloy
2.Finish:
CONTACT:G/F" Gold plated on conatct area;
G/F plated on solder tails, Base Nickel :50u" Min
3.Part number information:

SIM CARD	
PIN NO.	DESCRIPTION
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP

②	Terminal	6	COPPER ALLOY	
①	Housing	1	LCP UL 94V-0	BLACK
ITEM	PAPT NAMF	QTY	MATERIAL	FINISHING

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCE	



DESIGN	阿树	VIEW:	①	MODEL TYPE:	SIM CARD CONN
CHECKED		UNIT:	mm/in	PART NO.:	XKSIM-0605
APPROVED		SIZE:	A4	DWG NO.:	X-XKSIM-0605
XKB INDUSTRIAL PRECISION CO.,LIMITED				SCALE	PAGE
				N/A	1/1
				REVISION	A1